

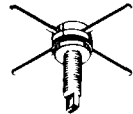
The RF Line
NPN Silicon
High Frequency Transistors

MRF542
MRF548

HIGH FREQUENCY
TRANSISTORS
NPN SILICON



MRF542
CASE 317D-02, STYLE 3
PLASTIC



MRF548
CASE 244A-01, STYLE 3
(TO-117)
CERAMIC

... designed primarily for high frequency common base amplifiers used in medium and high resolution color video display monitors.

- High Collector-Base Breakdown Voltage $V_{(BR)CBO} = 120$ V (Min)
- Stripline Opposed Base Construction
- Common Base Insertion Gain = 5.5 dB (Typ)
- Package Options for Low Cost (MRF542), High Power Dissipation (MRF548)
- **Die Source Same as MRF544**
- Emitter Ballasted for Improved Ruggedness

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------|------------|-------|
| Collector-Emitter Voltage | V_{CEO} | 70 | Vdc |
| Collector-Base Voltage | V_{CBO} | 120 | Vdc |
| Emitter-Base Voltage | V_{EBO} | 3 | Vdc |
| Collector-Current — Continuous | I_C | 400 | mAdc |
| Operating Junction Temperature | T_J | 150 200 | °C |
| Total Device Dissipation (at $T_C = 75^\circ\text{C}$ (1,2)) | MRF542 | 3 | Watts |
| | MRF548 | 5 | |
| | MRF542/548 | 40 | mW/°C |
| Derate above 75°C | | | |
| Storage Temperature Range | T_{stg} | 65 to +150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--------------------------------------|-----------------|-----|------|
| Thermal Resistance, Junction to Case | $R_{\theta JC}$ | 25 | °C/W |

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted.)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

OFF CHARACTERISTICS

| | | | | | |
|---|---------------|-----|---|-----|------|
| Collector-Emitter Breakdown Voltage ($I_C = 1$ mAdc, $I_B = 0$) | $V_{(BR)CEO}$ | 70 | — | — | Vdc |
| Collector-Base Breakdown Voltage ($I_C = 0.1$ mAdc, $I_E = 0$) | $V_{(BR)CBO}$ | 120 | — | — | Vdc |
| Emitter-Base Breakdown Voltage ($I_E = 0.1$ mAdc, $I_C = 0$) | $V_{(BR)EBO}$ | 3 | — | — | Vdc |
| Collector Cutoff Current ($V_{CE} = 80$ Vdc, $V_{BE} = 0$, $T_C = 25^\circ\text{C}$) | I_{CES} | — | — | 100 | μAdc |
| Collector Cutoff Current ($V_{CB} = 80$ Vdc, $I_E = 0$) | I_{CBO} | — | — | 20 | μAdc |

ON CHARACTERISTICS

| | | | | | |
|---|----------|----|---|---|---|
| DC Current Gain ($I_C = 50$ mAdc, $V_{CE} = 10$ Vdc) | h_{FE} | 15 | — | — | — |
|---|----------|----|---|---|---|

DYNAMIC CHARACTERISTICS

| | | | | | |
|--|----------|---|------|-----|----|
| Output Capacitance ($V_{CB} = 10$ Vdc, $I_E = 0$, $f = 1$ MHz) | C_{ob} | — | 2.9 | — | pF |
| Collector-Base Capacitance ($V_{CB} = 10$ Vdc, $I_E = 0$, $f = 1$ MHz) | C_{cb} | — | 2 | 2.5 | pF |
| Input Capacitance ($V_{EB} = 3$ Vdc, $f = 1$ MHz) | C_{ib} | — | 12.5 | — | pF |

FUNCTIONAL TESTS

| | | | | | |
|--|--------------|-----|-----|---|----|
| Common Base Gain ($V_{CB} = 10$ V, $I_C = 100$ mA, $f = 250$ MHz) | $ S_{21} ^2$ | 4.5 | 5.5 | — | dB |
|--|--------------|-----|-----|---|----|

(1) T_C , Case temperature measured on collector lead immediately adjacent to body of package.

(2) The MRF542 PowerMacro must be properly mounted for reliable operation. AN938, "Mounting Techniques in PowerMacro Transistor," discusses methods of mounting and heatsinking.

MRF542, MRF548

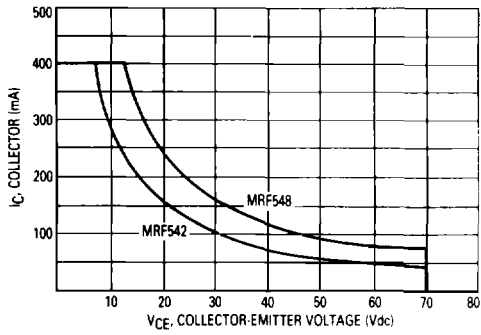


Figure 1. Safe Operating Area

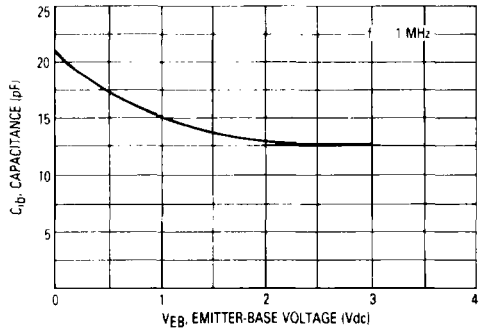


Figure 2. Input Capacitance versus Voltage

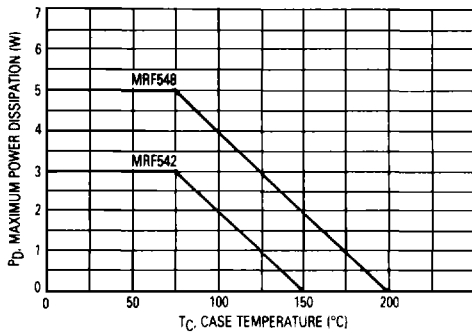


Figure 3. Power Dissipation versus Temperature

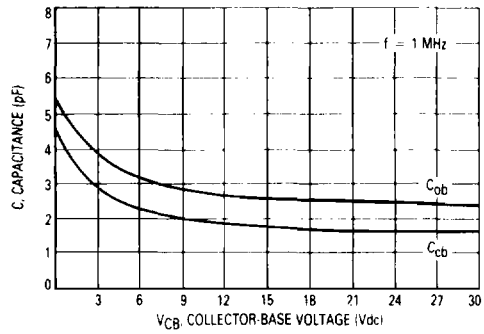


Figure 4. Junction Capacitance versus Voltage